

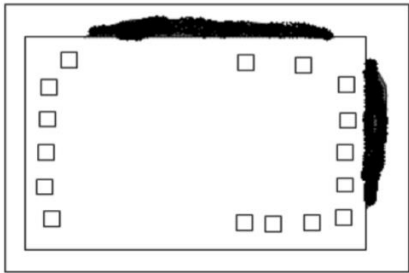
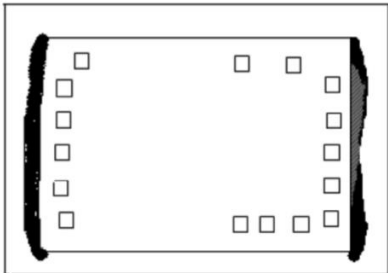


## SPECIFICATION FOR 3.3V LVPECL SMT OSCILLATOR MtronPTI P/N M2100S132

### Electrical Specifications:

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Frequency of Operation	F <sub>O</sub>		200.000000		MHz	
Frequency Stability						
vs. Temperature	ΔF/F	-20		+20	ppm	(Max-Min)/2
vs. Aging		-3		+3	ppm	1 <sup>st</sup> year
		-1		+1	ppm	Per year thereafter.
RF Output						
Output Type		LVPECL Compatible				
Output Load		50 Ω to (V <sub>CC</sub> – 2)			V	
Logic “1” Level Output	V <sub>OH</sub>	V <sub>CC</sub> – 1.02			V	
Logic “0” Level Output	V <sub>OL</sub>			V <sub>CC</sub> – 1.63	V	
Symmetry (Duty Cycle)	T <sub>DC</sub>	45		55	%	Ref. at 50% of waveform
Rise/Fall Time	T <sub>R</sub> /T <sub>F</sub>			0.35	nS	From 20% to 80% V <sub>CC</sub>
Tristate Enable Logic (Pad 1)		80% V <sub>DD</sub> or N/C			V	Pad 4 & 5: Output Enabled
Tristate Disable Logic (Pad 1)				0.35	V	Pad 4 & 5: Output to high Impedance
Supply Voltage & Power Consumption						
Operating Voltage	V <sub>CC</sub>	3.135	3.3	3.465	V	
Operating Current	I <sub>CC</sub>			130	mA	

### Special Requirements:

Parameter	Specification
Internal Visual	Parts shall comply with MIL-STD-883 Method 2017
	Die attach media shall be visible around at least 50 percent of the perimeter unless it is continuous on two full nonadjacent sides of the element.
	<div style="display: flex; justify-content: space-around; align-items: flex-end;"> <div style="text-align: center;">  <p>Reject less than 50% of perimeter Figure 2017-3</p> </div> <div style="text-align: center;">  <p>Minimum Accept two full non-adjacent sides Figure 2017-4</p> </div> </div>

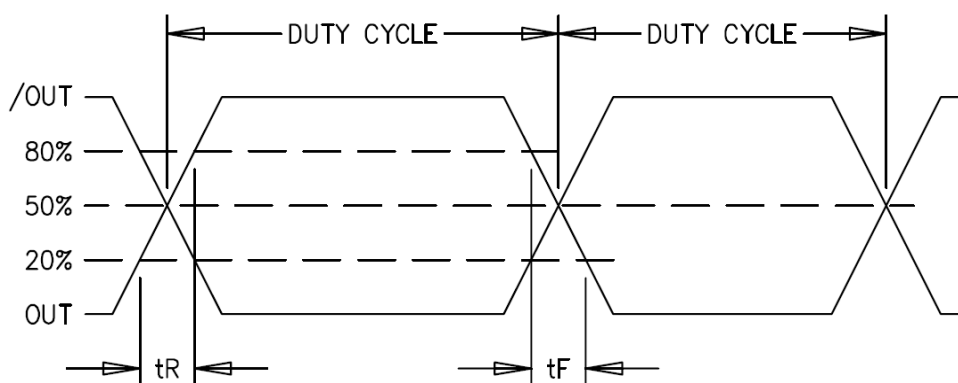


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### Environmental Conditions:

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Operating Temperature	T <sub>A</sub>	-40		+85	°C	
Storage Temperature	T <sub>S</sub>	-55		+125	°C	
Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)					
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)					
Thermal Shock	Per MIL-STD-883, Method 1011, Condition A					
Thermal Cycle	Per MIL-STD-883, Method 1010, Condition B					
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 <sup>-8</sup> atm cc/s of helium)					
Moisture Sensitivity Level (MSL)	MSL 1					
Solderability	Per EIAJ-STD-002					
Max. Soldering Conditions	See Figure 1.					
Package Type	6-pad 5.0 X 7.0 X 1.9 mm leadless ceramic. RoHS compliant.					

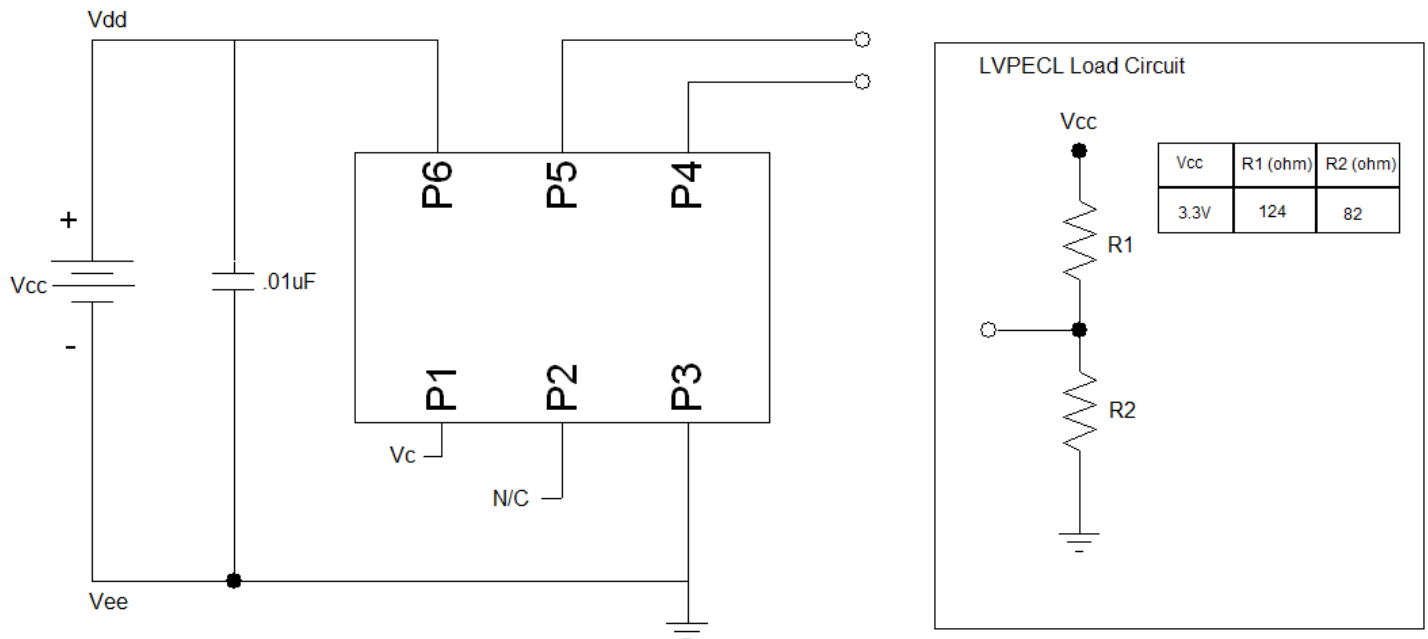
### Output Waveform:





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### Typical Test Circuit & Load Circuit Diagrams:



### Soldering Conditions:

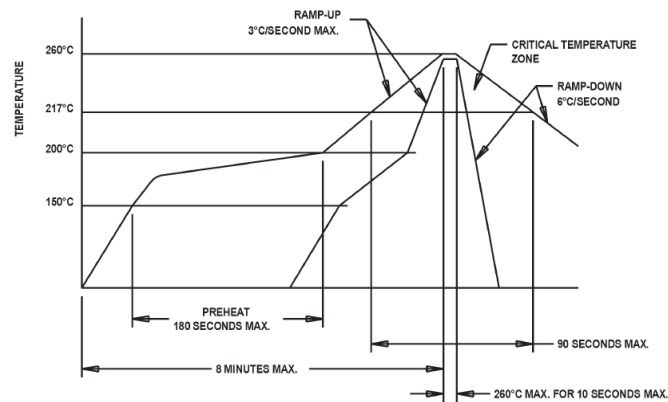


Figure 1



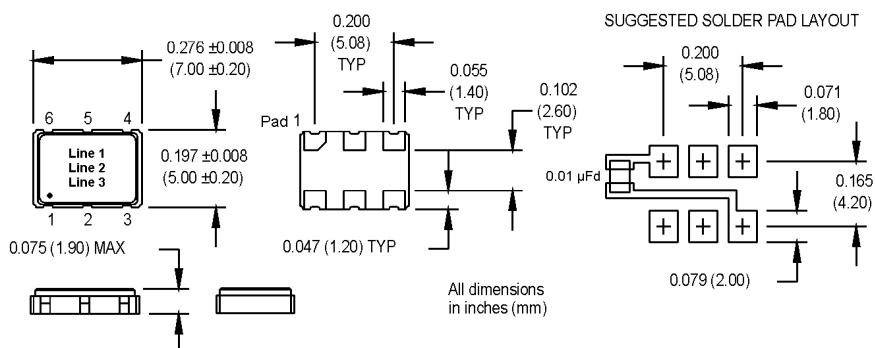
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### Mechanical, Marking, and Pin Out Information:

Part Marking	
Line 1	M2100S132
Line 2	200.000M
Line 3	yyww

Legend	
yy	Year
ww	Work week

Pin	Function
1	Tristate
2	N/C
3	Ground
4	Output
5	Complementary Output
6	+V <sub>CC</sub>



### Datasheet Revision Table:

Date	Rev.	Author	Details of Revision
07-14-20	A	MM	Original release.